NUVOGO™ 1000
The New Way of Imaging

NUVOGO™ 1000 is the latest addition to Orbotech’s Nuvo™ family of leading Direct Imaging (DI) solutions. Utilizing a high power laser and unique MultiWave Laser Technology™, the Nuvo™ 1000 provides maximum flexibility on a wide range of materials and applications. Incorporating Orbotech’s field-proven Large Scan Optics (LSO) Technology™ with its high depth-of-focus, it is a perfect match for Flex Solder Mask as well as for demanding Patterning and Solder Mask applications. This powerful system is designed for fast throughput while maintaining optimal quality.

Benefits

**Leading Mass Production Digital Imaging**
- In-line solution and fully-integrated automation for seamless production
- Optimized imaging time with dual table transport mechanism
- Fast and easy setup; operator friendly
- Clean, handling-free production environment

**MultiWave Laser Technology™ for Maximum Resist Flexibility**
- Embedded MultiWave Laser Technology™ ensures small undercut, excellent side walls and unmatched uniformity of line-structure quality
- High power laser enables high throughput with a wide range of materials and applications

**Highest Imaging Quality with LSO Technology™**
- Unique optics design for optimal line-structure and solder dam uniformity
- High depth-of-focus up to ±300μm for unmatched quality on changing surface topographies (especially for Solder Mask Flex applications)
- Advanced scaling modes for superior registration accuracy down to ±10μm

**Lower Total Cost of Ownership (TCO)**
- Optimized service cost per print
- Increased overall efficiency for significant long-term savings
- Suitable for a wide variety of resists, offering the option to use lower-cost materials
Nuvogo™ 1000 for State-of-the-Art Mass Production Digital Imaging

As part of the Nuvogo™ family, the Nuvogo™ 1000 utilizes Orbotech’s high power MultiWave Laser Technology™. Equipped with the industry’s most advanced optics and electronics, Nuvogo™ 1000 is designed to achieve fine structures at unmatched speed. The system achieves maximum productivity due to its dual table transport mechanism. Furthermore, Nuvogo’s fast setup capabilities and automatic acquisition of targets facilitate smooth job changes. Nuvogo™ 1000 also operates in a clean, hands free environment, thus ensuring no handling damage.

Orbotech High Power MultiWave Laser Technology™ for Maximum Resist Flexibility

Nuvogo™ 1000 is powered by Orbotech’s high power MultiWave Laser Technology™ which delivers unparalleled structure quality on a variety of resists and solder resists. It provides maximum flexibility to match any resist and to fit all forms and processes. The adaptable multi-wavelength laser also minimizes undercut to allow extremely smooth side walls.

Highest Imaging Quality With LSO Technology™

- **Registration Accuracy**
  - Registration accuracy down to ±10μm, enabling tight Solder Mask clearances
  - Annular rings with microvias can be stacked with greater precision

- **Innovative Scaling Modes**
  - Auto Scaling / Fixed Scaling / Group Scaling
  - Partial Scaling: sub-area registration for Solder Mask exposure

- **Depth-of-Focus (D.o.F.)**
  - D.o.F up to ±300μm for overcoming the most challenging surface topography changes and any distortion or abnormalities with the most advanced image quality
  - Single scan allows uniform imaging of the entire panel

- **Resolution and Line Uniformity**
  - Best line uniformity (down to 24μm in patterning)
  - Allows solder dams down to 50μm and SRO down to 75μm

- **Ease-of-Use**
  - Operator-friendly, intuitive graphical user interface
  - Seamless connectivity to CAM ensures fast and easy set-up
  - Recognizes a wide array of different target types to meet any production demands
  - Supports side-by-side Flex imaging

**Traceability**

Enables panel tracking by marking: serial number stamp; sub-panel and PCB; date and time stamp; scaling stamp and machine ID by alphanumeric stamping or 1-D barcode / 2-D barcode (Data Matrix Code).